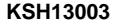
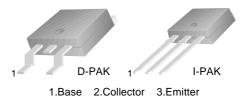


SEMICONDUCTOR IM



High Voltage Power Transistor D-PACK for Surface Mount Applications

- High speed Switching
- Suitable for Switching Regulator Motor Control
- Straight Lead (I.PACK, I Suffix)
- Lead Formed for Surface Mount Applications (No Suffix)



NPN Epitaxial Silicon Transistor

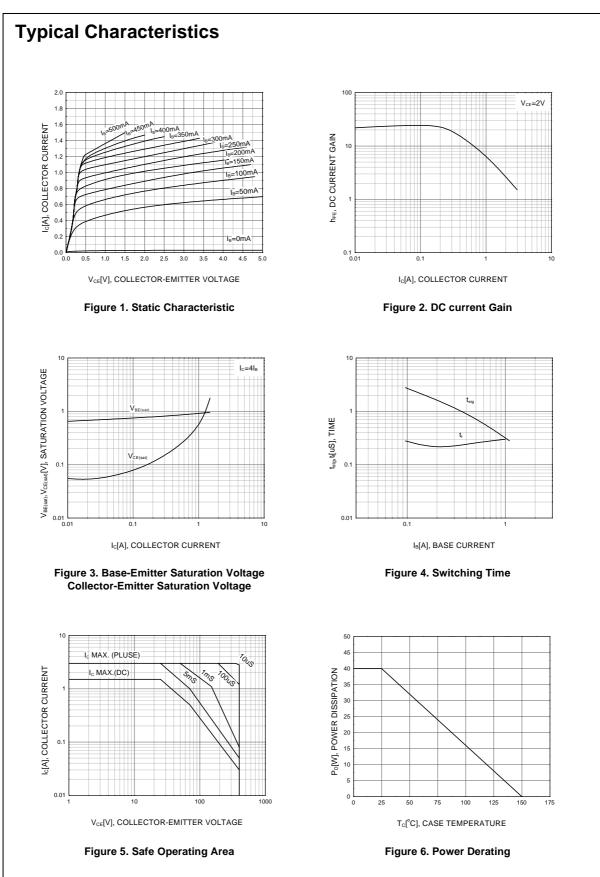
Absolute Maximum Ratings $T_{C}=25^{\circ}C$ unless otherwise noted

| Symbol | Parameter | Value | Units | |
|------------------|--|------------|-------|--|
| V _{CBO} | Collector-Base Voltage | 700 | V | |
| V _{CEO} | Collector-Emitter Voltage | 400 | V | |
| V _{EBO} | Emitter-Base Voltage | 9 | V | |
| I _C | Collector Current (DC) | 1.5 | A | |
| I _{CP} | Collector Current (Pulse) | 3 | A | |
| I _B | Base Current | 0.75 | A | |
| P _C | Collector Dissipation (T _C =25°C) | 40 | W | |
| TJ | Junction Temperature | 150 | °C | |
| T _{STG} | Storage Temperature | - 65 ~ 150 | °C | |

Electrical Characteristics T_C=25°C unless otherwise noted

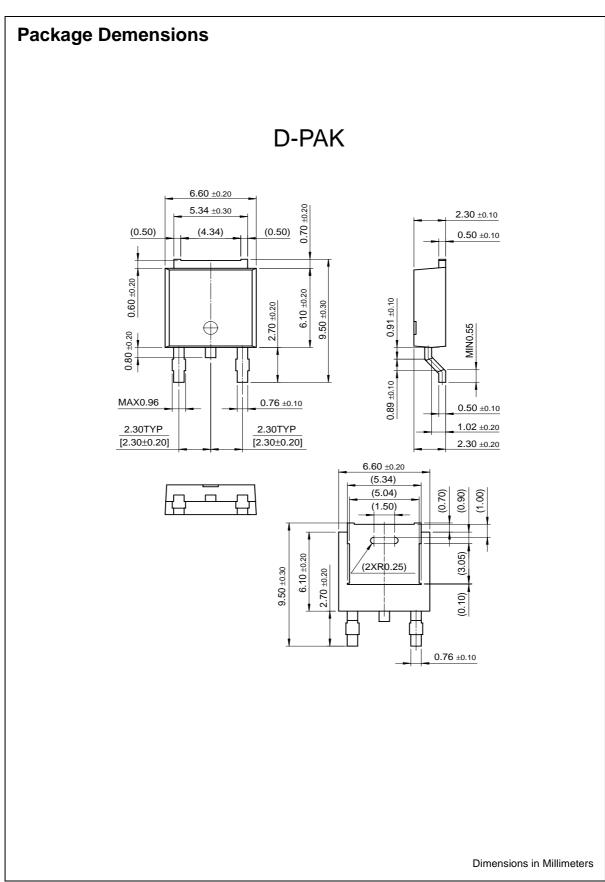
| Symbol | Parameter | Test Condition | Min. | Тур. | Max. | Units |
|------------------------|--|--|------|------|------|-------|
| V _{CEO} (sus) | * Collector-Emitter Breakdown Voltage | I _C = 5mA, I _B = 0 | 400 | | | V |
| I _{EBO} | Emitter Cut-off Current | $V_{EB} = 9V, I_{C} = 0$ | | | 10 | μA |
| h _{FE} | * DC Current Gain | $V_{CE} = 2V, I_{C} = 0.5A$ | 8 | | 40 | |
| | | $V_{CE} = 2V, I_{C} = 1A$ | 5 | | | |
| V _{CE} (sat) | * Collector-Emitter Saturation Voltage | $I_{\rm C} = 0.5 {\rm A}, I_{\rm B} = 0.1 {\rm A}$ | | | 0.5 | V |
| | | I _C = 1A, I _B = 0.25A | | | 1 | V |
| | | I _C = 1.5A, I _B = 0.5A | | | 3 | V |
| V _{BE} (sat) | * Base-Emitter Saturation Voltage | I _C = 0.5A, I _B = 0.1A | | | 1 | V |
| | | $I_{\rm C} = 1$ A, $I_{\rm B} = 0.25$ A | | | 1.2 | V |
| C _{ob} | Output Capacitance | V _{CB} = 10V, f = 0.1MHz | | 21 | | pF |
| f _T | Current Gain Bandwidth Product | $V_{CE} = 10V, I_{C} = 0.1A$ | 4 | | | MHz |
| t _{ON} | Turn ON time | V _{CC} = 125V, I _C = 1A | | | 1.1 | μs |
| t _{STG} | Storage time | I _B 1 = 0.2A, I _B 2 = - 0.2A | | | 4.0 | μs |
| t _F | Fall Time | 7 | | | 0.7 | μs |

* Pulse Test: Pulse Width=5ms, Duty Cycle≤10%



KSH13003

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|--------------------------|---------------------------|---|
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